

# 800mA Fast Ultra Low Dropout Linear Regulators

### **Features**

- Ultra low dropout voltage
- Low ground pin current
- Load regulation of 0.02%
- 15µA quiescent current in shutdown mode
- Guaranteed output current of 0.8A DC
- Available in TO-263 and TO-220 packages
- Output voltage accuracy ± 1.5%
- Sense option improves better load regulation (LP3964)
- Extremely low output capacitor requirements
- Overt emperature/overcurrent protection
- −40°C to +125°C junction temperature range

# TO-220-5 TO-263-5

## **Ordering Information**

| DEVICE         | Package Type | MARKING    | Packing | Packing Qty |
|----------------|--------------|------------|---------|-------------|
| LP3964T-1.8    | TO-220-5     | LP3964-1.8 | TUBE    | 1000pcs/Box |
| LP3964T-2.5    | TO-220-5     | LP3964-2.5 | TUBE    | 1000pcs/Box |
| LP3964T-3.3    | TO-220-5     | LP3964-3.3 | TUBE    | 1000pcs/Box |
| LP3964T-5.0    | TO-220-5     | LP3964-5.0 | TUBE    | 1000pcs/Box |
| LP3964T-ADJ    | TO-220-5     | LP3964-ADJ | TUBE    | 1000pcs/Box |
| LP3964S-1.8/TR | TO-263-5     | LP3964-1.8 | REEL    | 500pcs/Reel |
| LP3964S-2.5/TR | TO-263-5     | LP3964-2.5 | REEL    | 500pcs/Reel |
| LP3964S-3.3/TR | TO-263-5     | LP3964-3.3 | REEL    | 500pcs/Reel |
| LP3964S-5.0/TR | TO-263-5     | LP3964-5.0 | REEL    | 500pcs/Reel |
| LP3964S-ADJ/TR | TO-263-5     | LP3964-ADJ | REEL    | 500pcs/Reel |



## **General Description**

The LP3964 series of fast ultra low-dropout linear regulators operate from a +2.5V to +7.0V input supply. Wide range of preset output voltage options are available. These ultra low dropout linear regulators respond very fast to step changes in load which makes them suitable for low voltage microprocessor applications. The LP3964 are developed on a CMOS process which allows low quiescent current operation independent of output load current. This CMOS process also allows the LP3964 to operate under extremely low dropout conditions.

#### **Dropout Voltage:**

Ultra low dropout voltage; typically 24mV at 80mA load current and 240mV at 800mA load current.

#### **Ground Pin Current:**

Typically 4mA at 800mA load current.

#### **Shutdown Mode:**

Typically 15µA quiescent current when the shutdown pin is pulled low.

#### SENSE:

Sense pin improves regulation at remote loads.

#### **Precision Output Voltage:**

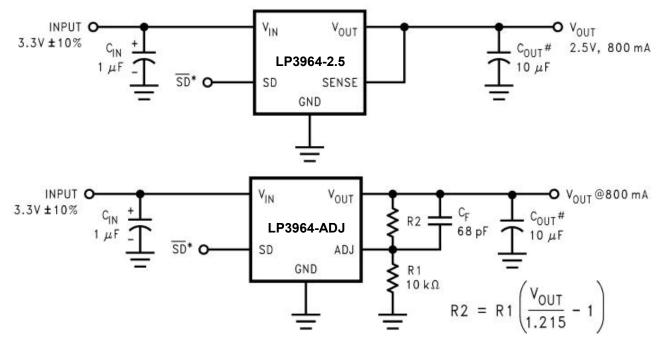
Multiple output voltage options are available ranging from  $1.8V \ 2.5V \ 3.3V \ 5.0V$  and adjustable , with a guaranteed accuracy of  $\pm 1.5\%$  at room temperature, and  $\pm 3.0\%$  over all conditions (varying line, load, and temperature).

## **Applications**

- Microprocessor power supplies
- GTL, GTL+, BTL, and SSTL bus terminators
- Power supplies for DSPs
- SCSI terminator
- Post regulators
- High efficiency linear regulators
- Battery chargers
- Other battery powered applications



# **Typical Application Circuits**

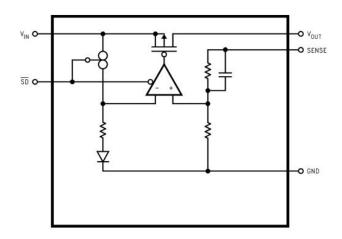


# Minimum output capacitance is 10  $\mu$ F to ensure stability over full load current range. More capacitance provides superior dynamic performance and additional stability margin.

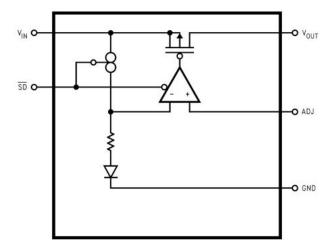
\*SD and ERROR pins must be pulled high through a  $10k\Omega$  pull-up resistor. Connect the ERROR pin to ground if this function is not used. See applications section for more information.



# **Block Diagram LP3964**

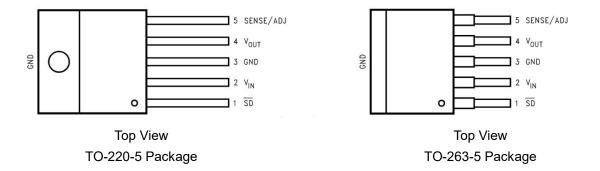


# **Block Diagram LP3964-ADJ**





# **Connection Diagrams**



# Pin Description for TO-220-5 and TO263-5 Packages

| Pin#   | LP3964                          |                     |  |  |  |
|--------|---------------------------------|---------------------|--|--|--|
| FIII # | Name                            | Function            |  |  |  |
| 1      | SD                              | Shutdown            |  |  |  |
| 2      | V <sub>IN</sub>                 | Input Supply        |  |  |  |
| 3      | GND                             | Ground              |  |  |  |
| 4      | V <sub>OUT</sub> Output Voltage |                     |  |  |  |
| 5      | SENSE/ADJ                       | Remote Sense Pin or |  |  |  |
| 5      | SEINSE/ADJ                      | Output Adjust Pin   |  |  |  |



# Absolute Maximum Ratings (Note 1)

| Condition                                     | Min                     | Max                    |  |
|---|-------------------------|------------------------|--|
| Storage Temperature Range                     | -65°C                   | +150°C                 |  |
| Lead Temperature: (Soldering,10 sec.)         | -                       | 245°C                  |  |
| ESD Rating (Note 3)                           | -                       | 2kV                    |  |
| Power Dissipation (Note 2)                    | Internally Limited      |                        |  |
| Input Supply Voltage (Survival)               | -0.3V                   | +7.5V                  |  |
| Shutdown Input Voltage (Survival)             | -0.3V                   | V <sub>IN</sub> +0.3V  |  |
| Output Voltage (Survival), (Note 6), (Note 7) | -0.3V                   | +7.5V                  |  |
| I <sub>OUT</sub> (Survival)                   | Short Circuit Protected |                        |  |
| Maximum Voltage for SENSE Pin                 | -                       | V <sub>OUT</sub> +0.3V |  |

# **Operating Ratings**

| Condition                                 | Min   | Max                   |
|---|-------|-----------------------|
| Input Supply Voltage (Operating)(Note 12) | 2.5V  | 7.0V                  |
| Shutdown Input Voltage (Operating)        | -0.3V | V <sub>IN</sub> +0.3V |
| Maximum Operating Current (DC)            | -     | 0.8A                  |
| Operating Junction Temp. Range            | -40°C | +125°C                |



## **Electrical Characteristics**

Limits in standard typeface are for TJ =  $25^{\circ}$ C, and limits in **boldface type** apply over the **full operating temperature range.** Unless otherwise specified:  $V_{IN} = V_{O(NOM)} + 1V$ ,  $I_L = 10$  mA,  $C_{OUT} = 10\mu$ F,  $V_{SD} = V_{IN} - 0.3V$ .

| <b>Symbol</b><br>Vo                   | Parameter  Output Voltage | VOUT+1V <v<sub>IN&lt;7.0V</v<sub>      | (Note 4) | Min                  | Max   | Units |  |
|---------------------------------------|---------------------------|--|----------|----------------------|-------|-------|--|
| Vo                                    |                           | VOUT+1V <v<sub>INI&lt;7 NV</v<sub>     |          |                      | ITIAA |       |  |
| Vo                                    |                           |  |          |                      |       |       |  |
| Vo                                    |                           | $10 \text{ mA} < I_L < 800 \text{ mA}$ |          | -1.5                 | +1.5  | %     |  |
|                                       | Tolerance                 | $3.135 \le V_{IN} \le 7.0$ for         | 0        | -3.0                 | +3.0  |       |  |
|                                       | (Note 8)                  | $V_{OUT} = 2.5V$                       |          |                      |       |       |  |
| ۸۷/0۱                                 | Output Voltage Line       | $V_{OUT}$ +1 $V$ < $V_{IN}$ <7.0 $V$ , | 0.02     |                      |       | 0/    |  |
| ∆VOL                                  | Regulation (Note 8)       |  | 0.06     |                      |       | %     |  |
| ۸۷/٥/                                 | Output Voltage Load       | $10 \text{ mA} < I_L < 800 \text{ mA}$ | 0.02     |                      |       |       |  |
| ΔVO/<br>ΔIOUT                         | Regulation                |  | 0.08     |                      |       | %     |  |
| ΔΙΟΟΊ                                 | (Note 8)                  |  |          |                      |       |       |  |
|                                       |                           | $I_L = 80 \text{ mA}$                  | 24       |                      | 30    |       |  |
| V - V                                 | Dropout Voltage           |  |          |                      | 35    | m\/   |  |
| VIN -VOUT                             | (Note 10)                 | $I_L = 800 \text{ mA}$                 | 240      |                      | 300   | mV    |  |
|                                       |                           |  |          |                      | 350   |       |  |
|                                       |                           | $I_L = 80 \text{ mA}$                  | 3        |                      | 9     |       |  |
| .                                     | Ground Pin Current In     |  |          |                      | 10    |       |  |
| I <sub>GND</sub> Normal Operation Mod | Normal Operation Mode     | $I_{L} = 800 \text{ mA}$               | 4        |                      | 14    | mA    |  |
|                                       |                           |  |          |                      | 15    |       |  |
|                                       | Ground Pin Current In     | $V_{SD} \le 0.2V$                      | 15       |                      | 25    |       |  |
| $I_{GND}$                             | Shutdown Mode             |  |          |                      | 75    | μA    |  |
|                                       | (Note 11)                 |  |          |                      |       |       |  |
| IO(PK)                                | Peak Output Current       | (Note 2)                               | 1.5      | 1.2                  |       | А     |  |
| 10(111)                               | r cak Output Ourrent      |  |          | 1.1                  |       |       |  |
| SHORT CIRC                            | CUIT PROTECTION           |  |          |                      |       |       |  |
| ISC                                   | Short Circuit Current     |  | 2.8      |                      |       | Α     |  |
| OVER TEMP                             | ERATURE PROTECTION        |  |          |                      |       |       |  |
| Tsh(t)                                | Shutdown Threshold        |  | 165      |                      |       | °C    |  |
| Tsh(h)                                | Thermal Shutdown          |  | 10       |                      |       | °C    |  |
| 1511(11)                              | Hysteresis                |  | 10       |                      |       | , C   |  |
| SHUTDOWN                              | INPUT                     |  |          |                      |       |       |  |
| V <sub>SDT</sub>                      | Chutdown Throshold        | Output = High                          | VIN      | V <sub>IN</sub> -0.3 |       | V     |  |
| VSDT                                  | Shutdown Threshold        | Output = Low                           | 0        |                      | 0.2   | V     |  |
| T <sub>dOFF</sub>                     | Turn-off delay            | I∟ = 800 mA                            | 20       |                      |       | μs    |  |
| T <sub>dON</sub>                      | Turn-on delay             | I∟ = 800 mA                            | 25       |                      |       | μs    |  |
| I <sub>SD</sub>                       | SD Input Current          | $V_{SD} = V_{IN}$                      | 1        |                      |       | nA    |  |



#### **Electrical Characteristics**

Limits in standard typeface are for TJ = 25°C, and limits in **boldface type** apply over the **full operating temperature range.** Unless otherwise specified:  $V_{IN} = V_{O(NOM)} + 1V$ ,  $I_L = 10$  mA,  $C_{OUT} = 10\mu$ F,  $V_{SD} = V_{IN} - 0.3V$ .

| Complete           | Downwater             | Conditions                                | Тур      | LP3964 (Note 5) |     | l luite     |  |  |
|--------------------|-----------------------|---|----------|-----------------|-----|-------------|--|--|
| Symbol             | Parameter             | Conditions                                | (Note 4) | Min             | Max | Units       |  |  |
|                    | AC PARAMETERS         |   |          |                 |     |             |  |  |
|                    | PSRR Ripple Rejection | V <sub>IN</sub> = V <sub>OUT</sub> + 1.5V |          |                 |     |             |  |  |
|                    |                       | C <sub>OUT</sub> = 100uF                  | 60       |                 |     |             |  |  |
| Debb               |                       | V <sub>OUT</sub> = 3.3V                   |          |                 |     | dB          |  |  |
| PORK               |                       | $V_{IN} = V_{OUT} + 0.3V$                 |          |                 |     | ub          |  |  |
|                    |                       | C <sub>OUT</sub> = 100uF                  | 40       |                 |     |             |  |  |
|                    |                       | V <sub>OUT</sub> = 3.3V                   |          |                 |     |             |  |  |
| p <sub>n(l/f</sub> | Output Noise Density  | f = 120Hz                                 | 0.8      |                 |     | μV          |  |  |
|                    | Output Noise Voltage  | BW = 10Hz – 100kHz                        | 150      |                 |     | ) / (=====) |  |  |
| en                 | (rms)                 | BW = 300Hz – 300kHz                       | 100      |                 |     | μV (rms)    |  |  |

**Note 1:** Absolute maximum ratings indicate limits beyond which damage to the device may occur. Operating ratings indicate conditions for which the device is in- tended to be functional, but does not guarantee specific performance limits. For guaranteed specifications and test conditions, see Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

Note 2: At elevated temperatures, devices must be derated based on package thermal resistance. The devices in TO220 package must be derated at  $\theta$ jA =  $50^{\circ}$ C/W (with 0.5in², 1oz. copper area), junction-to-ambient (with no heat sink). The devices in the TO263 surface-mount package must be derated at  $\theta$ jA =  $60^{\circ}$ C/W (with 0.5in2, 1oz. copper area), junction-to-ambient. The devices in SOT223 package must be derated at  $\theta$ jA =  $90^{\circ}$ C/W (with 0.5in2, 1oz. copper area), junction-to-ambient.

Note 3: The human body model is a 100pF capacitor discharged through a  $1.5k\Omega$  resistor into each pin.

Note 4: Typical numbers are at 25°C and represent the most likely parametric norm.

**Note 5:** Limits are 100% production tested at 25°C. Limits over the operating temperature range are guaranteed through correlation using Statistical Quality Control (SQC) methods. The limits are used to calculate National's Average Outgoing Quality Level (AOQL).

Note 6: If used in a dual-supply system where the regulator load is returned to a negative supply, the LP3964 output must be diode-clamped to ground.

**Note 7:** The output PMOS structure contains a diode between the  $V_{IN}$  and  $V_{OUT}$  terminals. This diode is normally reverse biased. This diode will get forward biased if the voltage at the output terminal is forced to be higher than the voltage at the input terminal. This diode can typically withstand 200mA of DC current and 1Amp of peak current.

**Note 8:** Output voltage line regulation is defined as the change in output voltage from the nominal value due to change in the input line voltage. Output voltage load regulation is defined as the change in output voltage from the nominal value due to change in load current. The line and load regulation specification contains only the typical number. However, the limits for line and load regulation are included in the output voltage tolerance specification.

**Note 9:** Dropout voltage is defined as the minimum input to output differential voltage at which the output drops 2% below the nominal value. Dropout voltage specification applies only to output voltages of 2.5V and above. For output voltages below 2.5V, the drop-out voltage is nothing but the input to output differential, since the minimum input voltage is 2.5V.

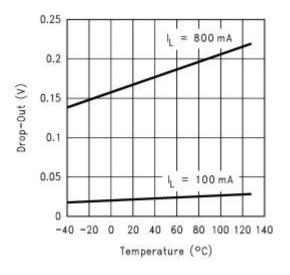
Note 10: This specification has been tested for  $-40^{\circ}\text{C} \le \text{TJ} \le 85^{\circ}\text{C}$  since the temperature rise of the device is negligible under shutdown conditions.



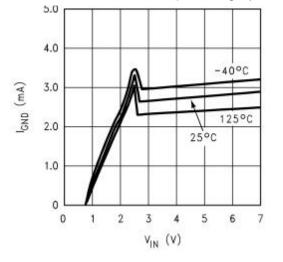
# **Typical Performance Characteristics**

Unless otherwise specified, VIN =VO(NOM) + 1V, VOUT= 2.5V, COUT =  $10\mu F$ , IOUT = 10mA, CIN =  $10\mu F$ , VSD = VIN, and TA =  $25^{\circ}C$ .

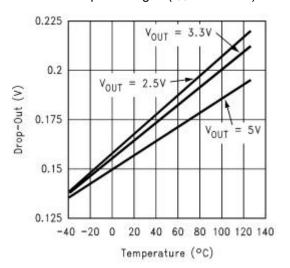
Drop-Out Voltage Vs Temperature for Different Load
Currents



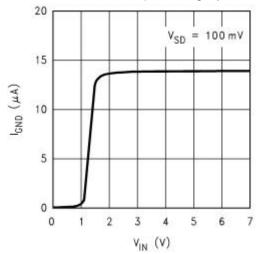
Ground Pin Current vs Input Voltage (V<sub>SD</sub>=V<sub>IN</sub>)



Drop-Out Voltage Vs Temperature for Different Output Voltages (I<sub>OUT</sub> = 800mA)

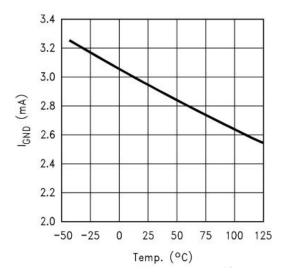


Ground Pin Current vs Input Voltage (V<sub>SD</sub>=100mV)

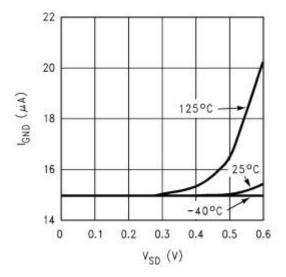




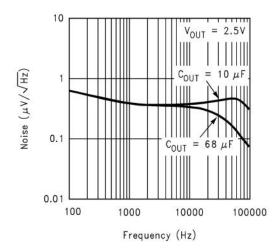
#### Ground Current Vs Temperature (V<sub>SD</sub>=V<sub>IN</sub>)



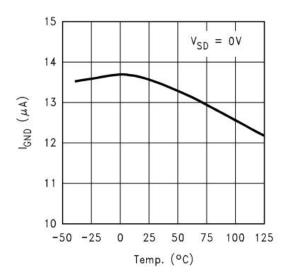
Ground Pin Current Vs Shutdown Pin Voltage



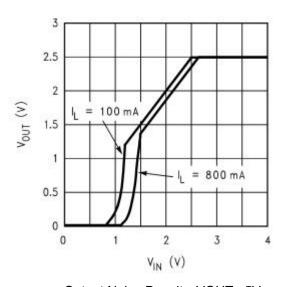
Output Noise Density, VOUT= 2.5V



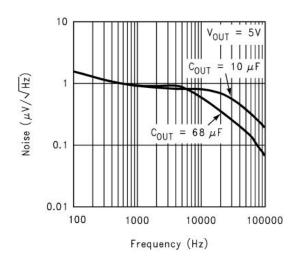
Ground Current Vs Temperature (V<sub>SD</sub>=0V)



Input Voltage Vs Output Voltage



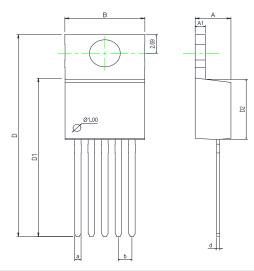
Output Noise Density, VOUT= 5V





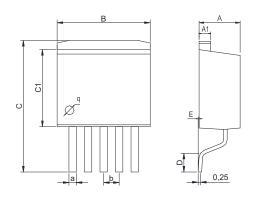
# **Physical Dimensions**

## TO-220-5



| Dimensions In Millimeters(TO-220-5) |      |      |      |      |      |      |      |      |         |
|-------------------------------------|------|------|------|------|------|------|------|------|---------|
| Symbol:                             | Α    | A1   | В    | D    | D1   | D2   | а    | d    | b       |
| Min:                                | 4.52 | 1.25 | 10   | 28.2 | 22.4 | 8.69 | 0.71 | 0.33 | 1.70BSC |
| Max:                                | 4.62 | 1.29 | 10.3 | 28.9 | 22.6 | 8.79 | 0.97 | 0.42 | 1.70000 |

## TO-263-5



| Dimensions In Millimeters(TO263-5) |      |      |      |      |      |      |      |      |         |
|------------------------------------|------|------|------|------|------|------|------|------|---------|
| Symbol:                            | А    | A1   | В    | С    | C1   | D    | E    | а    | b       |
| Min:                               | 4.45 | 1.22 | 10   | 13.7 | 8.40 | 1.90 | 0    | 0.71 | 1.70BSC |
| Max:                               | 4.62 | 1.32 | 10.4 | 14.6 | 8.90 | 2.10 | 0.20 | 0.97 | 1.70030 |



# **Revision History**

| DATE      | REVISION   | PAGE   |
|-----------|--|--------|
| 2014-6-23 | New  | 1-13   |
| 2023-7-24 | Modify the package dimension diagram TO220-5、Update encapsulation type、Update Lead Temperature | 11、1、6 |



#### **IMPORTANT STATEMENT:**

Huaguan Semiconductor reserves the right to change its products and services without notice. Before ordering, the customer shall obtain the latest relevant information and verify whether the information is up to date and complete. Huaguan Semiconductor does not assume any responsibility or obligation for the altered documents.

Customers are responsible for complying with safety standards and taking safety measures when using Huaguan Semiconductor products for system design and machine manufacturing. You will bear all the following responsibilities: Select the appropriate Huaguan Semiconductor products for your application; Design, validate and test your application; Ensure that your application meets the appropriate standards and any other safety, security or other requirements. To avoid the occurrence of potential risks that may lead to personal injury or property loss.

Huaguan Semiconductor products have not been approved for applications in life support, military, aerospace and other fields, and Huaguan Semiconductor will not bear the consequences caused by the application of products in these fields. All problems, responsibilities and losses arising from the user's use beyond the applicable area of the product shall be borne by the user and have nothing to do with Huaguan Semiconductor, and the user shall not claim any compensation liability against Huaguan Semiconductor by the terms of this Agreement.

The technical and reliability data (including data sheets), design resources (including reference designs), application or other design suggestions, network tools, safety information and other resources provided for the performance of semiconductor products produced by Huaguan Semiconductor are not guaranteed to be free from defects and no warranty, express or implied, is made. The use of testing and other quality control technologies is limited to the quality assurance scope of Huaguan Semiconductor. Not all parameters of each device need to be tested.

The documentation of Huaguan Semiconductor authorizes you to use these resources only for developing the application of the product described in this document. You have no right to use any other Huaguan Semiconductor intellectual property rights or any third party intellectual property rights. It is strictly forbidden to make other copies or displays of these resources. You should fully compensate Huaguan Semiconductor and its agents for any claims, damages, costs, losses and debts caused by the use of these resources. Huaguan Semiconductor accepts no liability for any loss or damage caused by infringement.

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Linear Voltage Regulators category:

Click to view products by HGSEMI manufacturer:

Other Similar products are found below:

LV5684PVD-XH MCDTSA6-2R L7815ACV-DG 714954EB ZMR500QFTA BA033LBSG2-TR LV5680P-E L79M05T-E L78LR05D-MA-E NCV317MBTG NTE7227 MP2018GZD-33-P MP2018GZD-5-P LV5680NPVC-XH LT1054CN8 UA78L09CLP UA78L09CLPR CAT6221-PPTD-GT3 MC78M09CDTRK NCV51190MNTAG 78M05 HT7150-1 UM1540DB-18 XC6234H281VR-G WL2834CA-6/TR TPL730F33-5TR TLS850F1TA V50 TPS549B22RVFR UM1540DB-33 WL9200P3-50B WL9100P3-33B XC6219B152MR WL2855K33-3/TR PJ54BM33SE PJ9500M25SA MD7218E33PC1 H7533-2PR SK7812AU SD1A30 78L33 TP78L33T3 SK6513ST3A-50 SK6054D4-09 SK6054D4-18 SK6054D4-11 SK6054D4-10 LM79L12F HLP2985AIM5X-5.0 HLP2992AIM5X-5.0/NOPB HMIC5205-5.0YM5-TR